

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Dr. Harry Barowski	08/25/2010
Thomas Brunschwiler	08/26/2010
Dr. Hubert Harrer	09/08/2010
Dr. Andreas Huber	08/31/2010
Bruno Michel	08/25/2010
Tim Niggemeier	08/25/2010
Stephan Paredes	08/25/2010
Jochen Supper	09/06/2010

RECEIVING PARTY DATA

Name:	International Business Machines Corporation
Street Address:	New Orchard Road
City:	Armonk
State/Country:	NEW YORK
Postal Code:	10504

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12914644

CORRESPONDENCE DATA

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 Address Line 2: IBM-Intellectual Property Law
 Address Line 4: Austin, TEXAS 78758-3493

CH \$40.00 12914644

ATTORNEY DOCKET NUMBER:	DE920100025US1
NAME OF SUBMITTER:	Diana R. Gerhardt
Total Attachments: 6 source=DE920100025US1_Assignment#page1.tif source=DE920100025US1_Assignment#page2.tif source=DE920100025US1_Assignment#page3.tif source=DE920100025US1_Assignment#page4.tif source=DE920100025US1_Assignment#page5.tif source=DE920100025US1_Assignment#page6.tif	

ASSIGNMENT

Whereas, the undersigned Inventor(s) has/have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") in:

Title of the Invention:

OPTIMIZED SEMICONDUCTOR PACKAGING IN A THREE-DIMENSIONAL STACK

and further identified by the IBM Docket Number provided above in the header of this Assignment, for which an application for a United States Patent was executed concurrently herewith or was filed having:

Serial Number: (insert series code and serial number here if/when available)

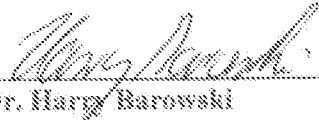
Whereas, International Business Machines Corporation, a corporation of New York having a place of business at Armonk, New York (herein referred to as "IBM"), desires to acquire, and each undersigned Inventor desires to grant to IBM, the entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto,

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Pages Follow]

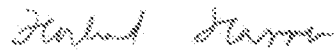
Executed by Inventor 1 of 8

Signature:  Date: 08/12/2010
Dr. Harry Barowski

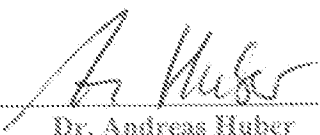
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Signature: _____ Date: _____
Thomas Brunschweiler

Executed by Inventor 3 of 8

Signature:  Date: 9/8/2010
Dr. Hubert Harrer

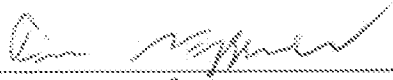
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Signature:  Date: 08/31/2010
Dr. Andreas Huber

Executed by Inventor 5 of 8

Signature: _____ Date: _____
Bruno Michel

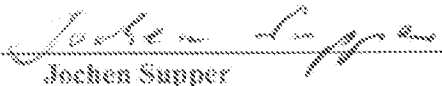
Executed by Inventor 6 of 8

Signature:  Date: 08/25/2010
Tim Niggemeier

Executed by Inventor 7 of 8

Signature: _____ Date: _____
Stephan Paredes

Executed by Inventor 8 of 8

Signature:  Date: 09/16/2010
Jochen Supper

ASSIGNMENT

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Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned Inventor ("ASSIGNOR") hereby sells, assigns, and otherwise transfers to IBM (the "ASSIGNEE"), its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, each undersigned Inventor hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to IBM, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by IBM, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned Inventor agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in IBM, its successors, legal representatives, and assigns, whenever requested by IBM, its successors, legal representatives, or assigns.

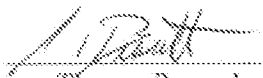
Each undersigned Inventor acknowledges their prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to IBM and is unaware of any reason why they may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. Each undersigned Inventor also hereby grants IBM, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent application Serial Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

[Inventor Signature Pages Follow]

Executed by Inventor 1 of 8

Signature: _____ Date: _____
Dr. Harry Barowski

Executed by Inventor 2 of 8

Signature:  _____ Date: 26. Aug. 2010
Thomas Brunschweiler

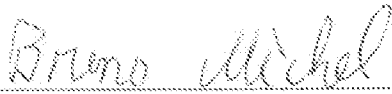
Executed by Inventor 3 of 8

Signature: _____ Date: _____
Dr. Hubert Harrer

Executed by Inventor 4 of 8

Signature: _____ Date: _____
Dr. Andreas Huber

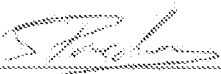
Executed by Inventor 5 of 8

Signature:  _____ Date: 25. Aug. 2010
Bruno Michel

Executed by Inventor 6 of 8

Signature: _____ Date: _____
Tim Niggermeier

Executed by Inventor 7 of 8

Signature:  _____ Date: 25.08.2010
Stephan Paredes

Executed by Inventor 8 of 8

Signature: _____ Date: _____
Jochen Supper